# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





### DATASHEET

## SMD • Side View LEDs (0.8mm) EAPL2812RA0

PRELIMINARY



#### **Features**

- Side view LED.
- Lead frame package with individual 2 pins.
- Wide viewing angle.
- Soldering methods: IR reflow soldering.
- ESD protection.
- Pb-free.
- The product itself will remain within RoHS compliant version.

#### Description

Due to the package design, this series has wide viewing angle , low power consumption and white LEDs are devices . This feature makes the LED ideal for light guide application.

#### Applications

- LCD Back Light.
- Mobile phones .
- Indicators.
- Illuminations.
- Switch Lights.

#### **Device Selection Guide**

Chip Materials	Emitted Color	Resin Color
AlGaInP	Brilliant Red	Water Clear

#### Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V <sub>R</sub>	5	V	
Forward Current	I <sub>F</sub>	50	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I <sub>FP</sub>	100	mA	
Power Dissipation	Pd	120	mW	
Junction Temperature	Tj	115	°C	
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90	°C	
The way of Decistory of	Rth <sub>J-A</sub>	500	K/W	
Thermal Resistance	Rth <sub>J-S</sub>	300	K/W	
ESD	ESD <sub>HBM</sub>	2000	V	
(Classification acc. AEC Q101)	ESD <sub>MM</sub>	200	V	
Soldering Temperature	T <sub>sol</sub>	Reflow Soldering : 260 $^\circ\!\mathrm{C}$ for 10 sec. Hand Soldering : 350 $^\circ\!\mathrm{C}$ for 3 sec.		

#### Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	140		360	mcd	I <sub>F</sub> =20mA
Viewing Angle	<b>2</b> θ <sub>1/2</sub>		120		deg	I <sub>F</sub> =20mA
Peak Wavelength	λр		632		nm	I <sub>F</sub> =20mA
Dominant Wavelength	λd	617.5		633.5	nm	I <sub>F</sub> =20mA
Spectrum Radiation Bandwidth	Δλ		20		nm	I <sub>F</sub> =20mA
Forward Voltage	V <sub>F</sub>	1.75		2.35	V	I <sub>F</sub> =20mA
Reverse Current	I <sub>R</sub>			50	μA	$V_R=5V$

Note:

1. Tolerance of Luminous Intensity: ±11%

Tolerance of Dominant Wavelength: ±1nm
Tolerance of Forward Voltage: ±0.1V

#### **Bin Range of Luminous Intensity**

Bin Code	Min.	Max.	Unit	Condition
R2	140	180		
S1	180	225		
S2	225	285	mcd	I <sub>F</sub> =20mA
T1	285	360		

Note:

Tolerance of Luminous Intensity: ±11%

#### **Bin Range of Dominant Wavelength**

Bin Code	Min.	Max.	Unit	Condition
E4	617.5	621.5		
E5	621.5	625.5		
E6	625.5	629.5	nm	I <sub>F</sub> =20mA
E7	629.5	633.5		

Note:

Tolerance of Dominant Wavelength: ±1nm

#### **Bin Range of Forward Voltage**

Bin Code	Min.	Max.	Unit	Condition
0	1.75	1.95		
1	1.95	2.15	V	I <sub>F</sub> =20mA
2	2.15	2.35		

Note:

Tolerance of Forward Voltage: ±0.1V



Ta=25¢&

2.8

3.0

Ta=25¢&

10

Ta=25🕸

30¢X

40¢X

50¢X

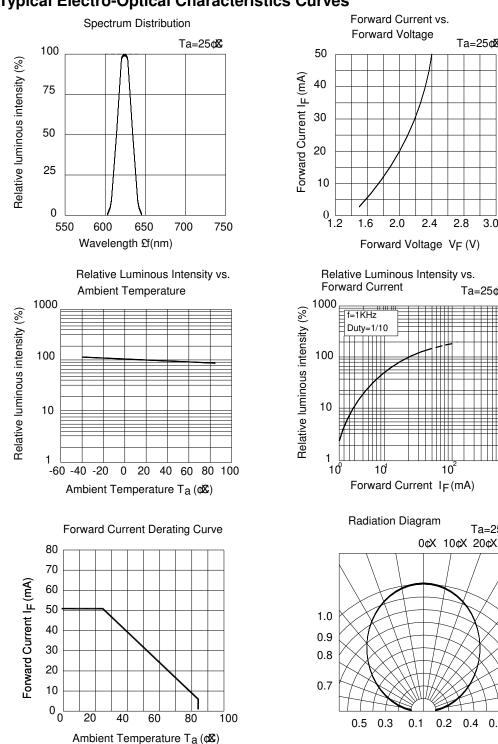
60¢X

70¢X

80¢X

90¢X

0.4 0.6

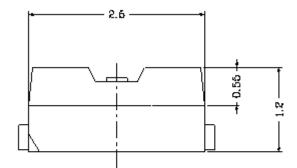


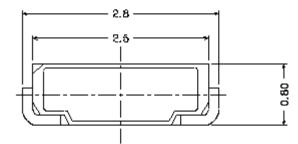
#### **Typical Electro-Optical Characteristics Curves**

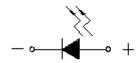
DATASHEET SMD • Side View LEDs (0.8mm) EAPL2812RA0



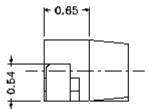
#### **Package Dimension**

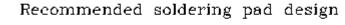


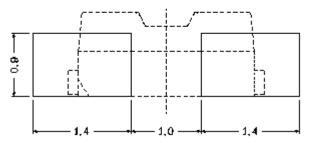


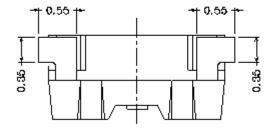


Polarity









Note: Tolerances unless mentioned ±0.1mm. Unit = mm



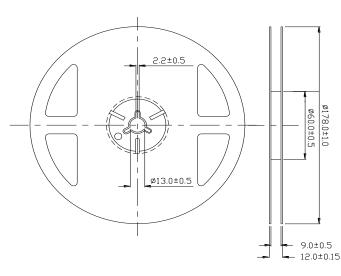
#### **Moisture Resistant Packing Materials**

#### Label Explanation

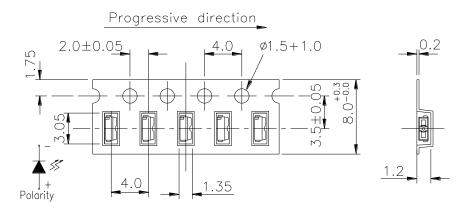


#### **Reel Dimensions**

- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

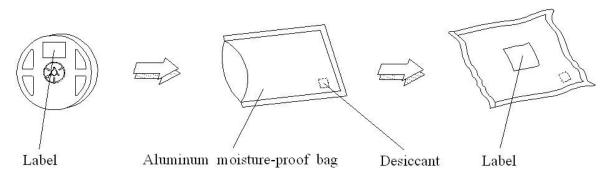


#### Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel



Note: Tolerances unless mentioned ±0.1mm. Unit = mm

#### **Moisture Resistant Packing Process**

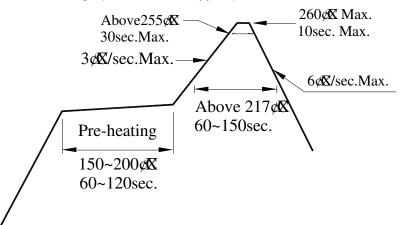


Note: Tolerances unless mentioned ±0.1mm. Unit = mm

#### **Precautions for Use**

#### 1. Over-current-proof

1.1 Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).



#### 2. Storage

2.1 Moisture proof bag should only be opened immediately prior to usage.

2.2 Environment should be less than 30  $^\circ\!\mathrm{C}$  and 60% RH when moisture proof bag is opened.

2.3 After opening the package MSL Conditions stated on page 1 of this spec should not be exceeded.

2.4 If the moisture sensitivity card indicates higher than acceptable moisture, the component should be baked at min. 60deg  $\pm$ -5deg for 24 hours.

#### 3. Soldering Condition

- 3.1 Pb-free solder temperature profile
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less

than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

#### **Application Restrictions**

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

#### **Revision History**

Rev.	Modified date	File modified contents
1	2014/05/08	New Spec